

# The SESAME XAFS fluorescence detector project

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XVI International Conference on Science, Arts and Culture  
International Conference on SESAME - in honour of Paolo Budinich

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# Outline

- Introduction
  - XAFS and the fluorescence detector
- The SESAME fluorescence detector
  - The detector design
  - Results from a parallel development: TwinMic at Elettra
- Conclusions

# What is XAFS?

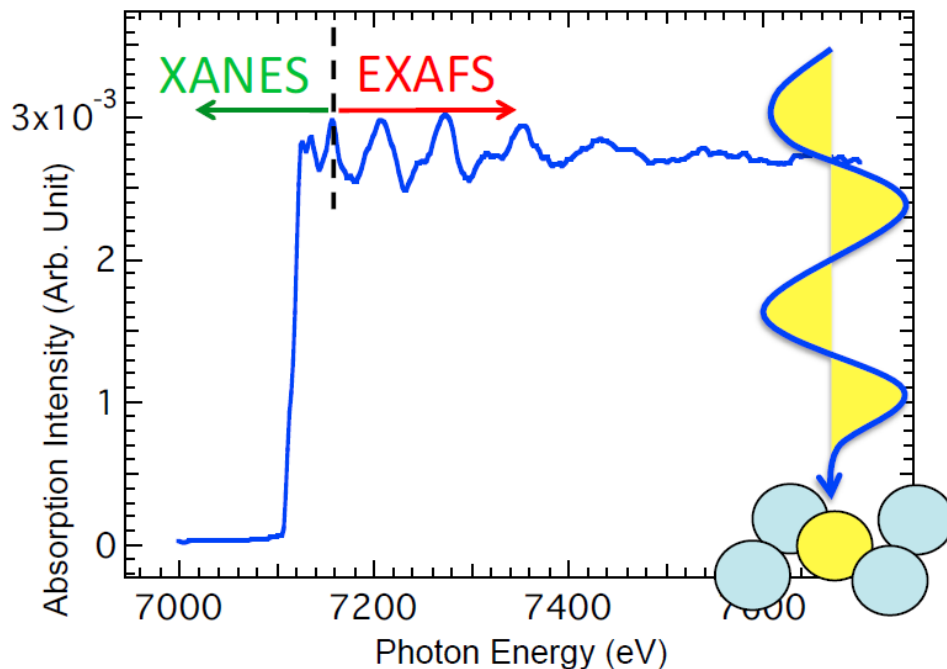
XAFS: **X**-ray **A**bsorption **F**ine **S**tructure

electronic state  
(valence)  
Symmetry

Bond length

Number of surrounding atoms (Coordination number)

Distribution, Thermal vibration



**Element specific**

to observe **Local structure**

(long range periodicity is not required)

Solid, Liquid, Gas, whatever

XANES: X-ray Absorption Near Edge Structure

EXAFS: Extended X-ray Absorption Fine Structure

Source: Hitoshi Abe, *A Brief Introduction to XAFS*

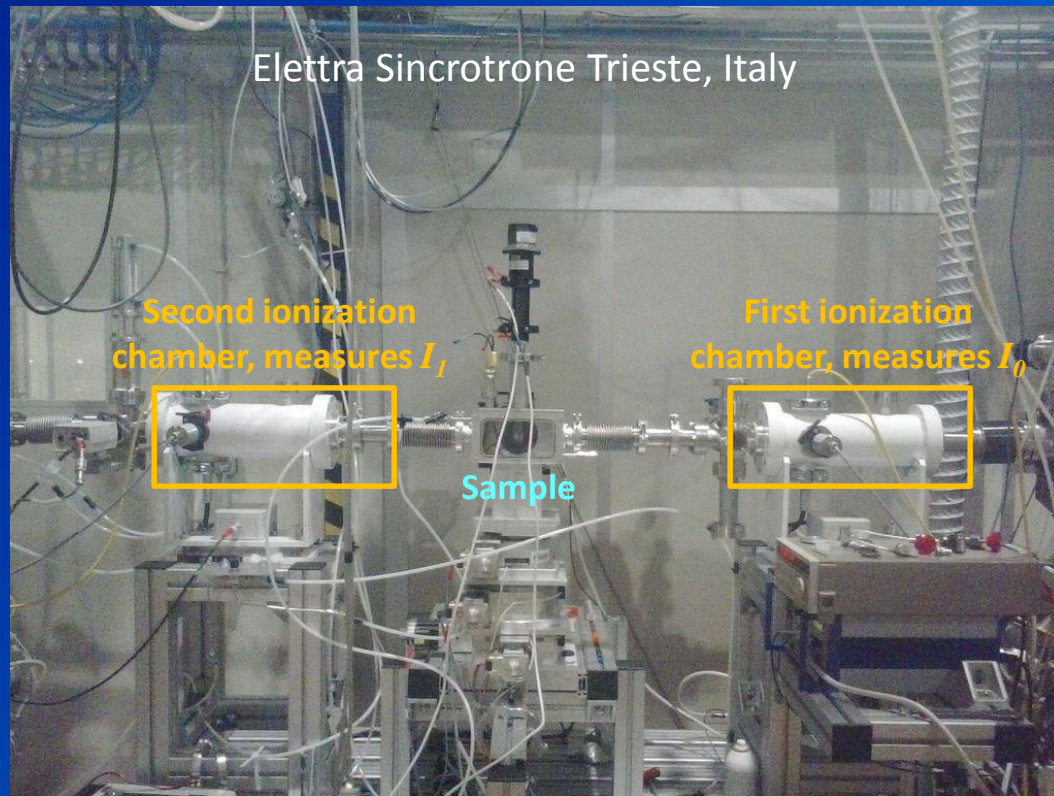
[http://www.sesame.org.jo/sesame/images/News/Users\\_meeting\\_and\\_JSPS\\_School/jspss-lectures/Lec04\\_Abe.pdf](http://www.sesame.org.jo/sesame/images/News/Users_meeting_and_JSPS_School/jspss-lectures/Lec04_Abe.pdf)

# A typical XAFS beamline

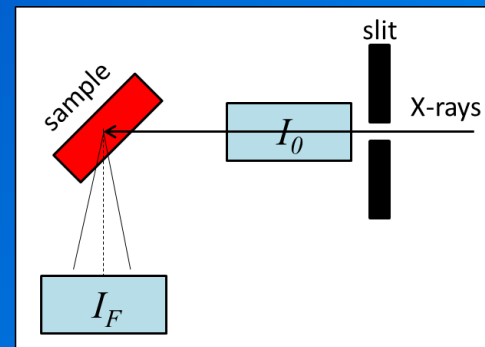


- The energy of the output X-ray beam is precisely set by a double crystal monochromator that provides an energy resolution  $\Delta E/E \approx 10^{-4}$
- The beam size at the sample is defined by the exit slits
- The X-ray flux is  $\approx 10^{11} - 10^{12}$  ph/s $\cdot$ mm $^2$

# A typical XAFS experimental station



When the sample is thick but diluted or thin but concentrated, the measurement can be carried out in fluorescence mode



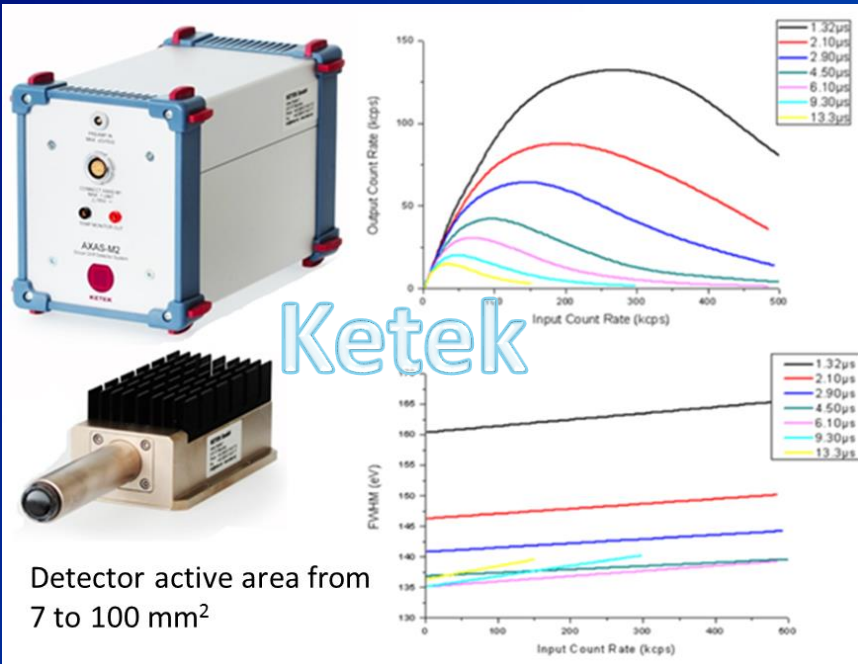
$$\mu = \alpha \frac{I_F}{I_0}$$

# XAFS fluorescence detector specs?

In our context, a XAFS measurement is the measurement of the fluorescence flux from the sample during a very fine energy scan around the absorption edge of the material under examination, hence:

- The detector needs to have a good sensitivity in the whole energy range of the beamline → 3 – 30 keV for SESAME
- The energy resolution of the detector should be good enough to allow for rejection of undesired signals, i.e. scattered beam or other fluorescence lines close to the investigated one →  $E_{RES} < 150 \text{ eV FWHM @ } 5.9 \text{ keV}$
- The detector needs to cope with large fluxes of photons  
→ small detection units to reduce pileup probability
- The geometric acceptance of the detector should be as large as possible to reduce the measurement time → multi-channel systems

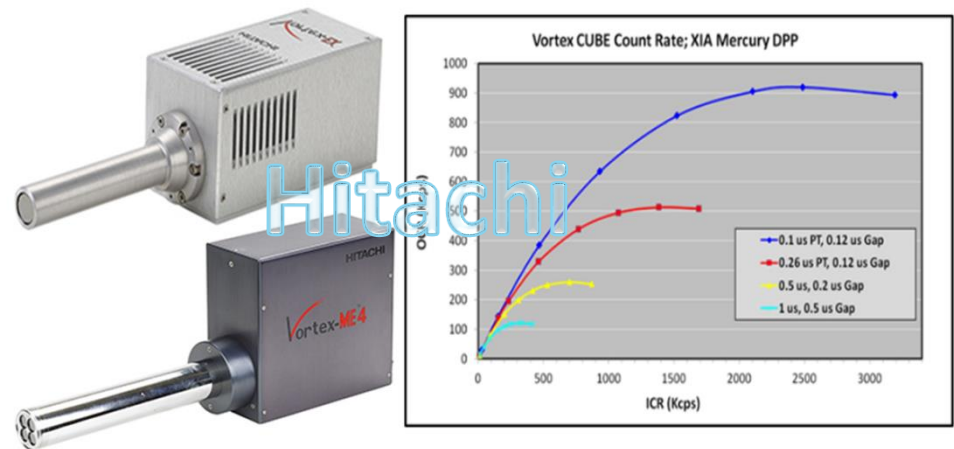
# Some commercial systems



- A range of silicon drift detector sizes, from 150 mm<sup>2</sup> to 20 mm<sup>2</sup>
- **X-Max<sup>N</sup>** provides a superb resolution that is independent of sensor size
- Excellent low energy analysis, including Be detection guaranteed on all sensor sizes
- Up to four X-Max<sup>N</sup> can run in parallel on one microscope to create a system with a total active area of 600 mm<sup>2</sup>



- Top performances SDD with active area from 5mm<sup>2</sup> to 100mm<sup>2</sup>.
- Equipped with the state-of-the-art Pulsed-reset Charge-preamplifier XGL-CPA-2100.
- Optionally includes the XGL-MCSH-3100 and the XGL POWER SUPPLY to set-up a complete stand-alone **X-ray** spectroscopic system.



- Available in thickness of 0.5 and 1 mm
- Available single detectors in 30, 40, 50, 65, 70, 80 mm<sup>2</sup>
- Large area, four-element silicon drift detector (total area of 120 mm<sup>2</sup> - 200 mm<sup>2</sup>)

# Multi-channel commercial solution



SGX Sensortech

Sensor	# of channels				
Sensor type		SDD			
Active area (mm <sup>2</sup> )	10      40	65	100	170	
Thickness		450µm			
Collimated area (mm <sup>2</sup> )	7      30	50	80	150	
Resolution (eV)	<133      <133	<133	136	139	
P/B ratio		>10,000 : 1			
FET or 'CUBE <sup>(2)</sup> ' primary stage		Option			
Peltier cooled cryostat		Standard			
Temperature stabilisation		Standard			

Interesting solution, but few drawbacks:

- large area easily obtainable with large sensors, difficult with smaller ones
- made up of single detector systems, each one requires a power supply and a MCA and a lot of cables
- bulky (not necessarily bad)

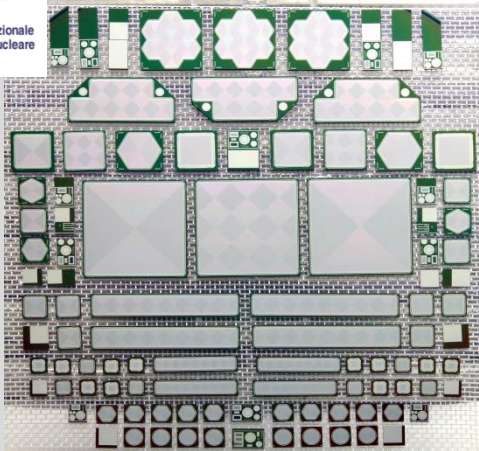


# SESAME detector concept

The detector concept we proposed to SESAME is the result of a thorough discussion with the XAFS beamline scientists at Elettra, for which we are developing the same exact detector:

- a multi-channel system with cells as small as feasible to reduce pileup, the limit is due to the constraints on the hybrid layout  
→ 9 mm<sup>2</sup> a good compromise
- the total sensitive area should allow at least an order of magnitude gain on the measurement time → 64 cells, 576 mm<sup>2</sup> (currently 80 mm<sup>2</sup>)
- the system should be segmented, rather than monolithic, to allow for redundancy → 8 units, each comprising a detection head and a backend PCB
- the system should be compact and should contain the whole acquisition chain including the MCAs → On board digital signal processing

# Heritage – detector R&Ds



## *INFN (Trieste, Bologna and TIFPA)*

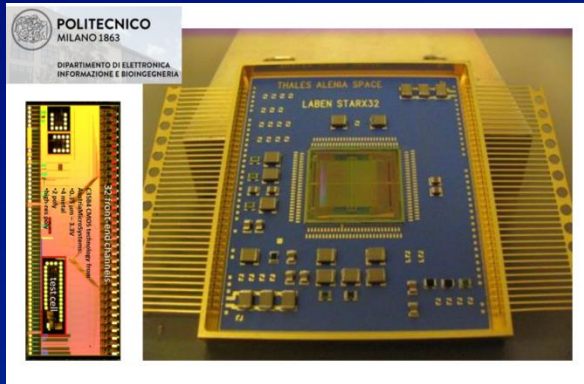
- Silicon detector design: device simulation, layout, characterization, and assembly
- Expertise in optimizing large-area SDDs for applications on different research fields
- Expertise in design and construction of complex multi-channel detector systems
- Expertise in digital signal processing

## *FBK - Center for Materials and Microsystems*

- Expertise in development of advanced solid-state sensors in dedicated technology processes
- Sensor design and simulations, physical design, tuning of the fabrication process, electrical and optical characterization
- 6" wafer microfabrication facility with a 500 m<sup>2</sup>, class 10/100 Clean Room and a 0.8  $\mu$ m CMOS pilot line

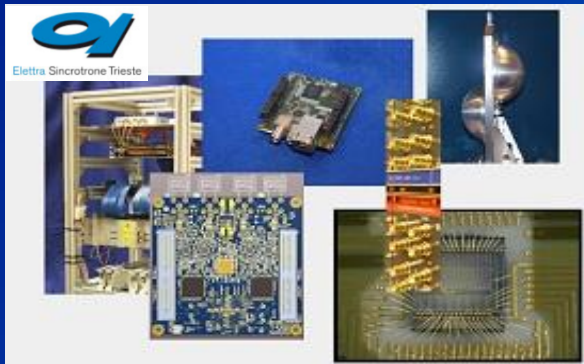


# Heritage – ASICs and DAQ systems



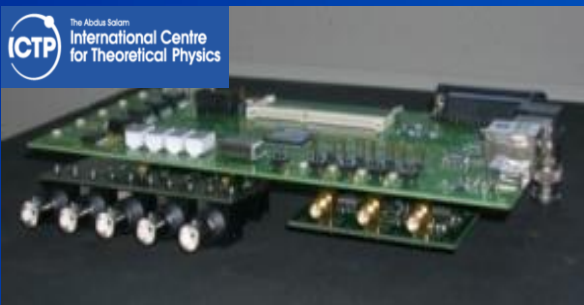
## *Politecnico di Milano – DEIB*

- Characterization of GaAs, CdTe, CZT, Si and SiC radiation detectors
- Design of ASICs for radiation detectors
- Low-noise Low-Power Electronics



## *Elettra – Instrumentation and Detectors Laboratory*

- Development of special instrumentation and boards for many applications: FAST STM scanning and acquisition electronics, LLRF systems and bipolar HV power supplies, picoammeters, electron energy analyzers and fast feedback electronics
- Deep knowledge of Synchrotron beamlines requirements



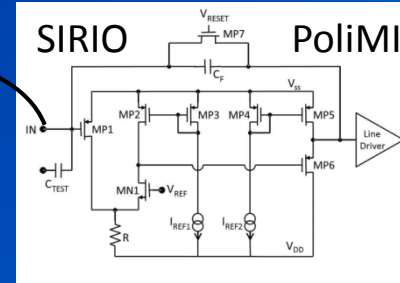
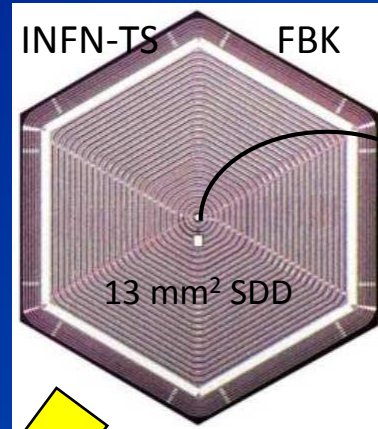
## *ICTP-INFN Microprocessor laboratory*

- Expertise in design of FPGA based acquisition systems and digital signal processing for scientific instrumentation
- Expertise in training and education of researchers coming from developing countries

# Starting point: state-of-the-art technology

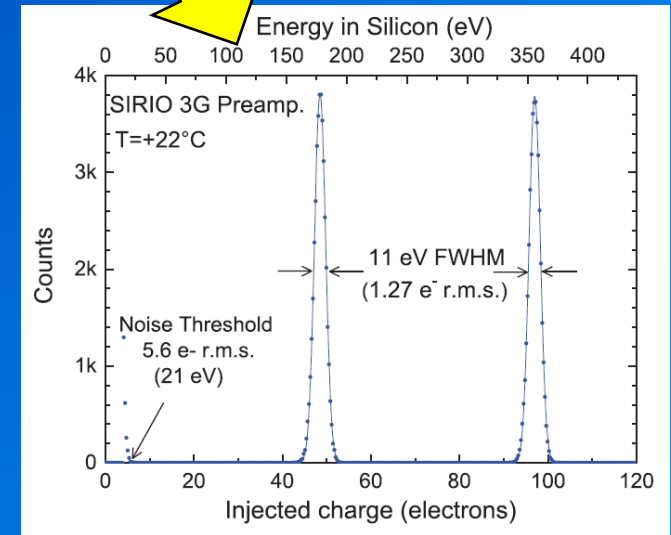
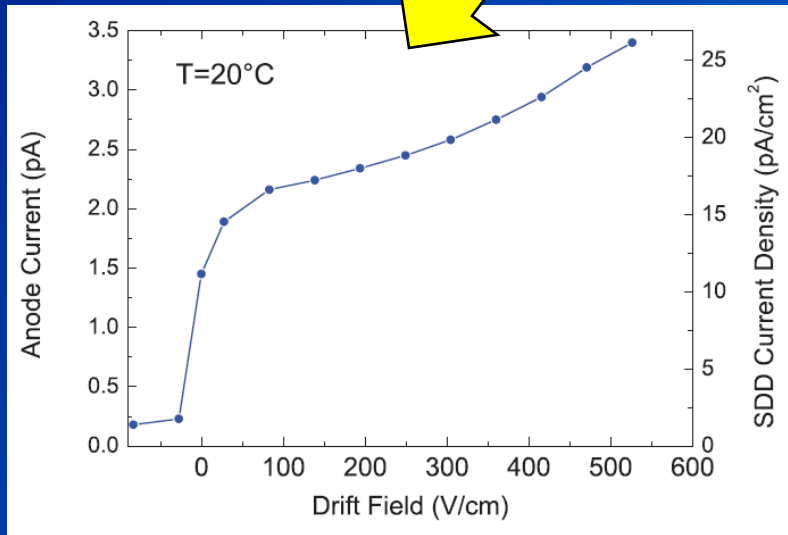
Very-low leakage current production process was developed at FBK

- Typical:  $< 150 \text{ pA/cm}^2$
- Minimum:  $25 \text{ pA/cm}^2$



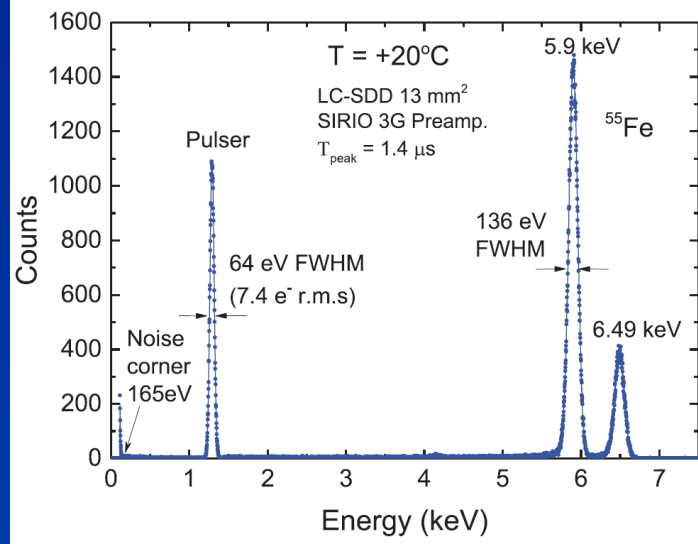
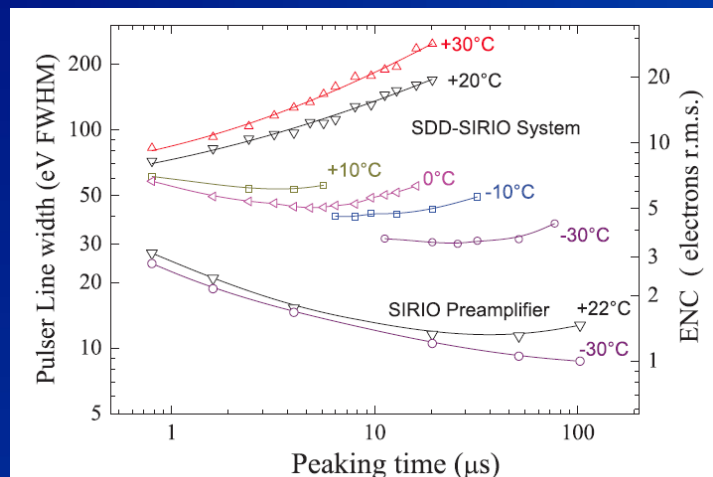
Low-power and very-low noise optimized preampl. in sub-micron technology

- Power: 10 mW including the output buffer
- ENC of  $1.27 \text{ e}^- \text{ r.m.s. at } 20^\circ \text{C}$



G. Bertuccio, et al., IEEE TRANSACTIONS ON NUCLEAR SCIENCE, VOL. 63, NO. 1, FEBRUARY 2016

# Room temperature spectroscopy in sight

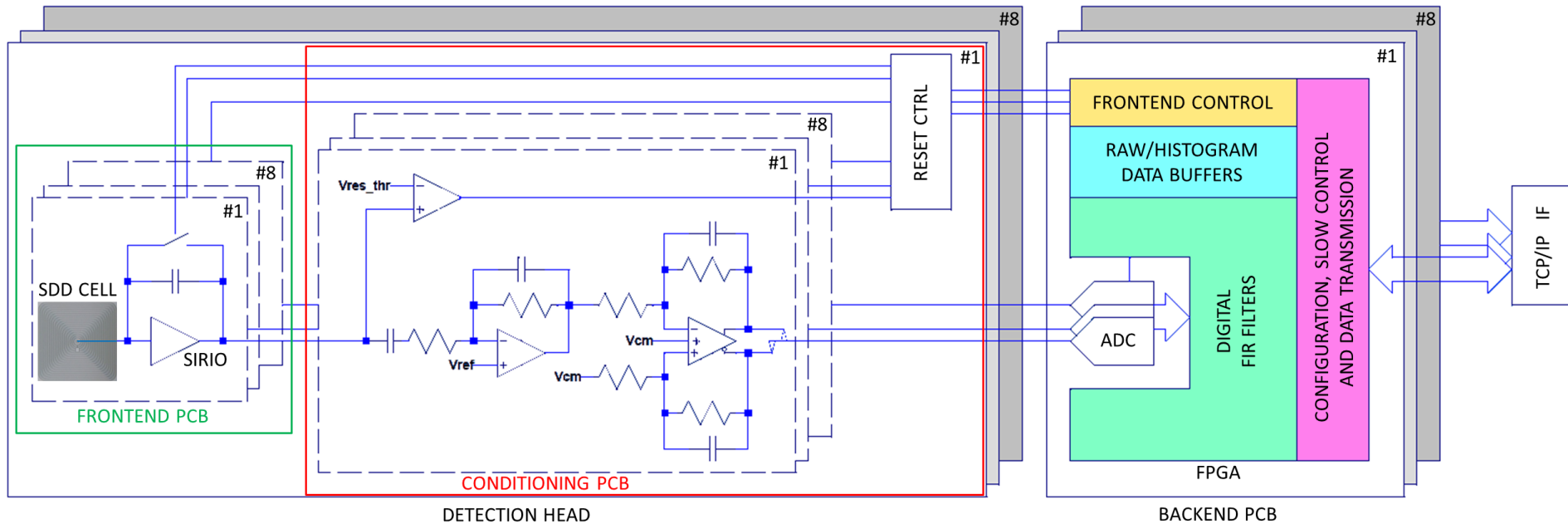


T ( $^\circ\text{C}$ )	$^{55}\text{Fe}$ 5.9 keV LINE WIDTH (eV FWHM)	PULSER LINE WIDTH (eV FWHM)	ENC (e- r.m.s.)	Peaking Time ( $\mu\text{s}$ )
+30	148	82	9.4	0.8
+20	136	64	7.4	1.4
+10	133	53	6.1	2.4
0	129	44	5.0	4.8
-10	129	41	4.7	9.6
-30	123.7	29	3.3	19.2
READOUT ELECTRONICS				
+22	--	11	1.27	51.2
-30	--	8.7	1.0	102.4

- Very-low noise preamplifiers allow the reduction of the shaping time, hence
  - ✓ increased throughput
  - ✓ less sensitivity to leakage current
- Very-low leakage detectors then allow to avoid bulky and power-hungry cooling systems

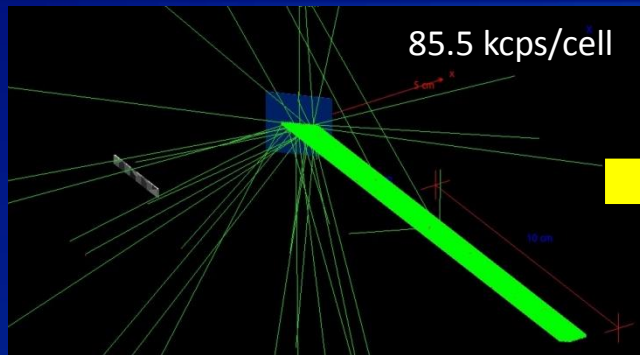
G. Bertuccio, et al., IEEE TRANSACTIONS ON NUCLEAR SCIENCE, VOL. 63, NO. 1, FEBRUARY 2016

# SESAME detector block scheme

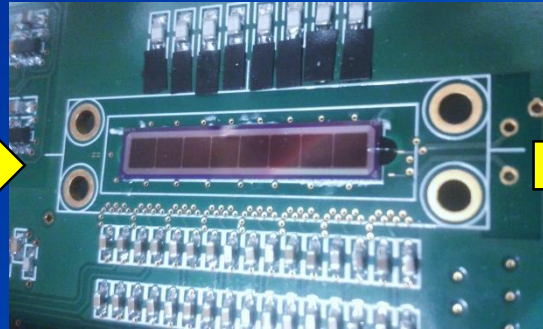


- Each unit comprises a detection head and a backend section
- The detection head hosts the frontend PCB and signal conditioning circuitry (CR-RC<sup>2</sup>)
- The detector is controlled by a PC through a TCP/IP connection

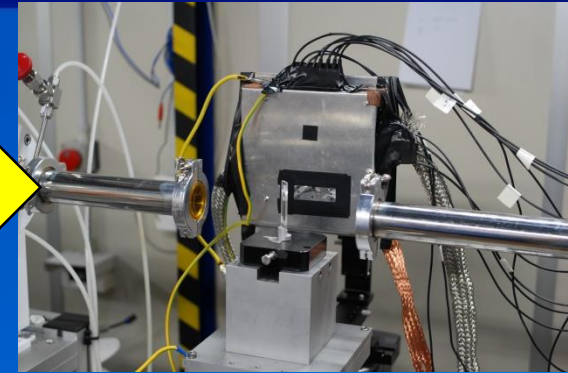
# Detection head: sensor cell sizing



GEANT4 simulation



Prototype



Beamline test

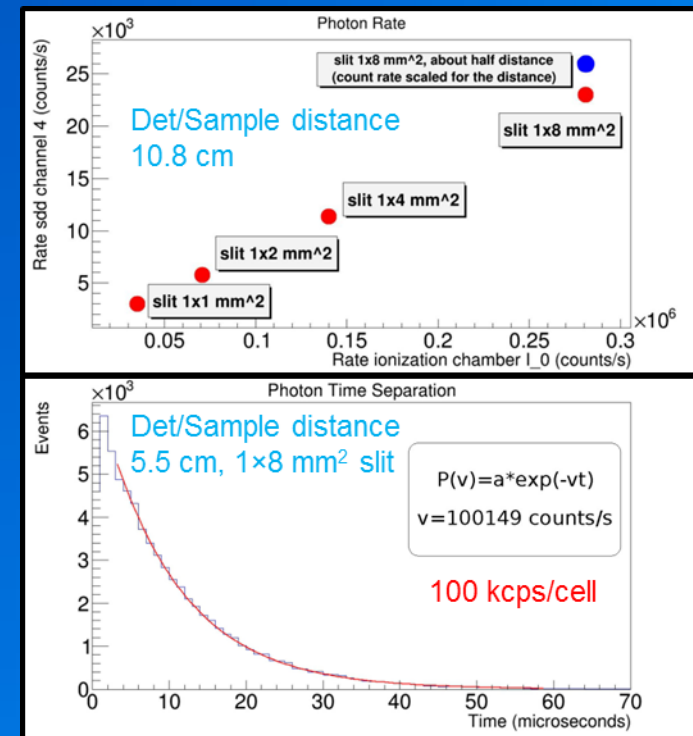
## Prototype detector:

- the analogue signals from the 8 preamplifiers are sampled by a 40 MSPS, 12 bit, 8-channel ADC
- the digital data is transmitted to a PC and saved to disk
- a LabVIEW acquisition software is used to control the detector and acquire raw spectra (filtering not yet optimized)

## Beam test condition:

- detector operated near room temperature
- Worst measurement conditions: laminated samples of Mn ( $K_{\alpha}$  @ 5.89 keV,  $K_{\beta}$  @ 6.49 keV) and Zr ( $K_{\alpha}$  @ 15.75 keV,  $K_{\beta}$  @ 17.67 keV)

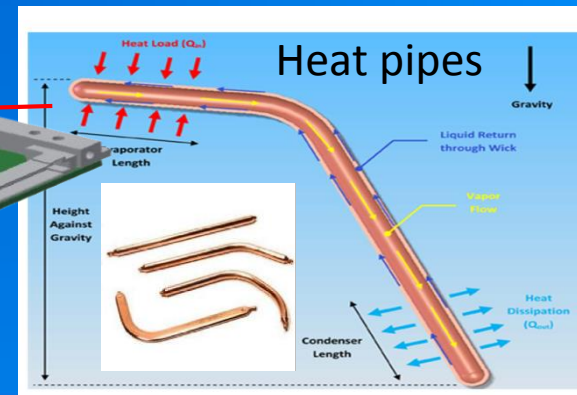
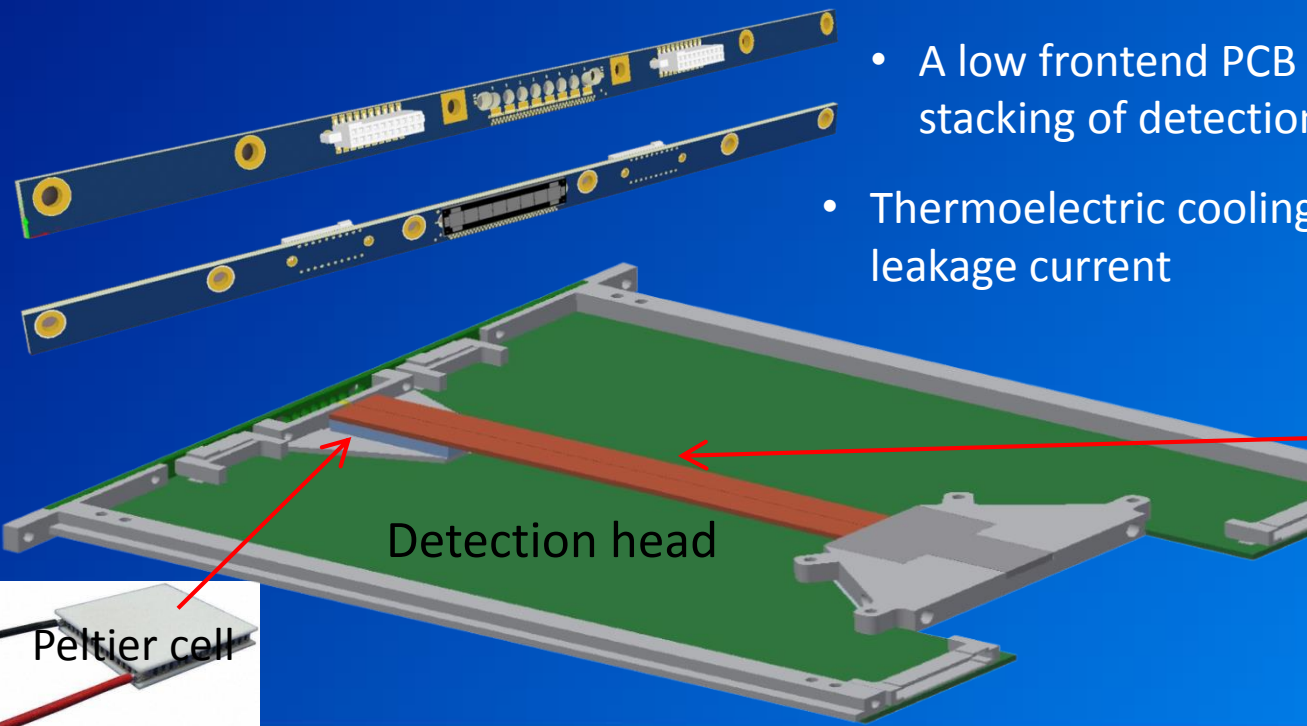
Pileup events: 18% for  $t_R = 1 \mu s$  (9% for a count rate of 50 kcps/cell)



# Detection head design

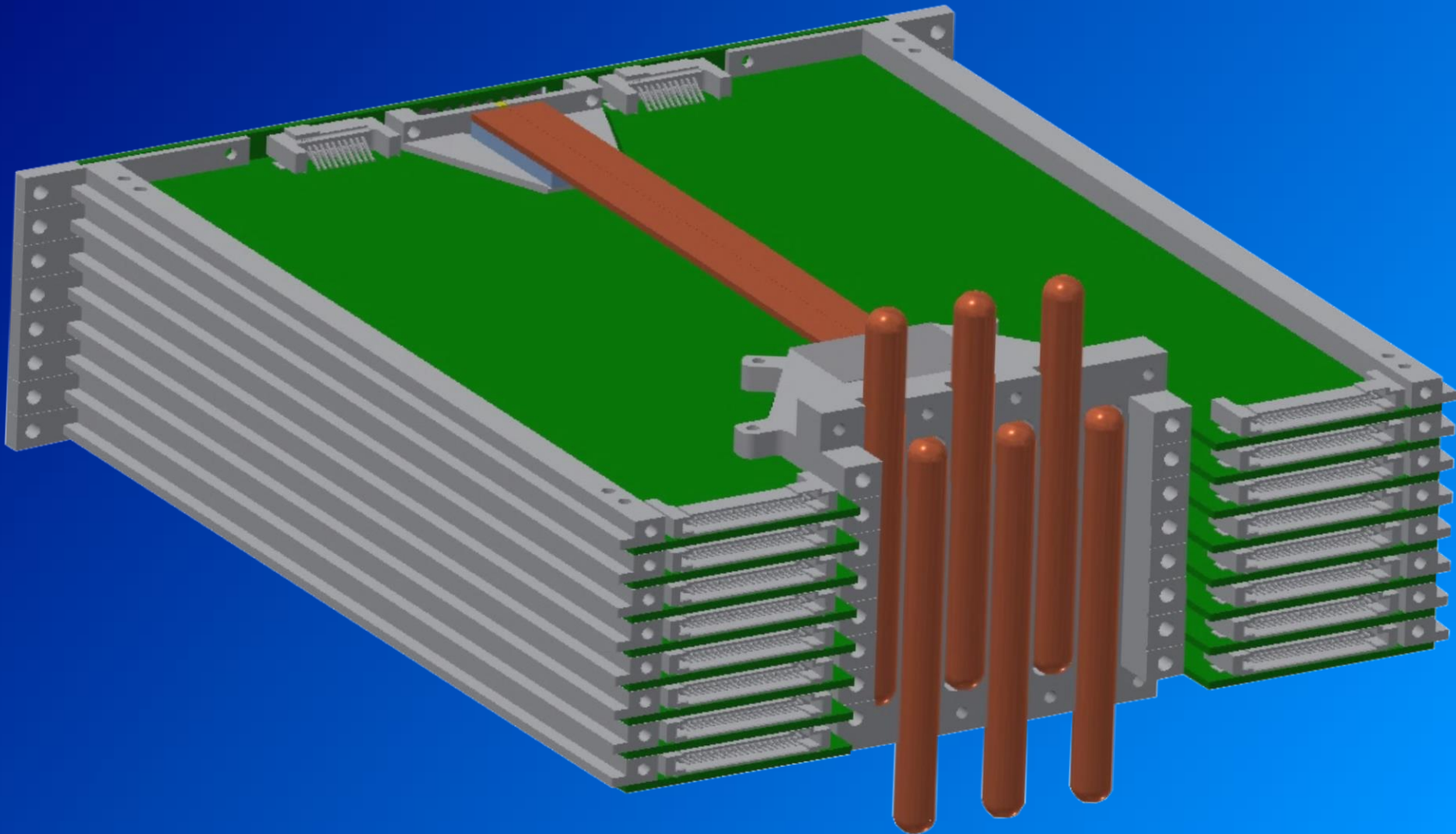


- Improved detector layout:
  - better defined sensitive area
  - on-board thermistors for temperature control
- Tungsten collimator to minimize “split” events
- New SIRIO preamplifier prototypes optimized for SESAME now under test at Politecnico di Milano
  - A low frontend PCB profile allows for compact stacking of detection heads
- Thermoelectric cooling is employed to reduce the leakage current

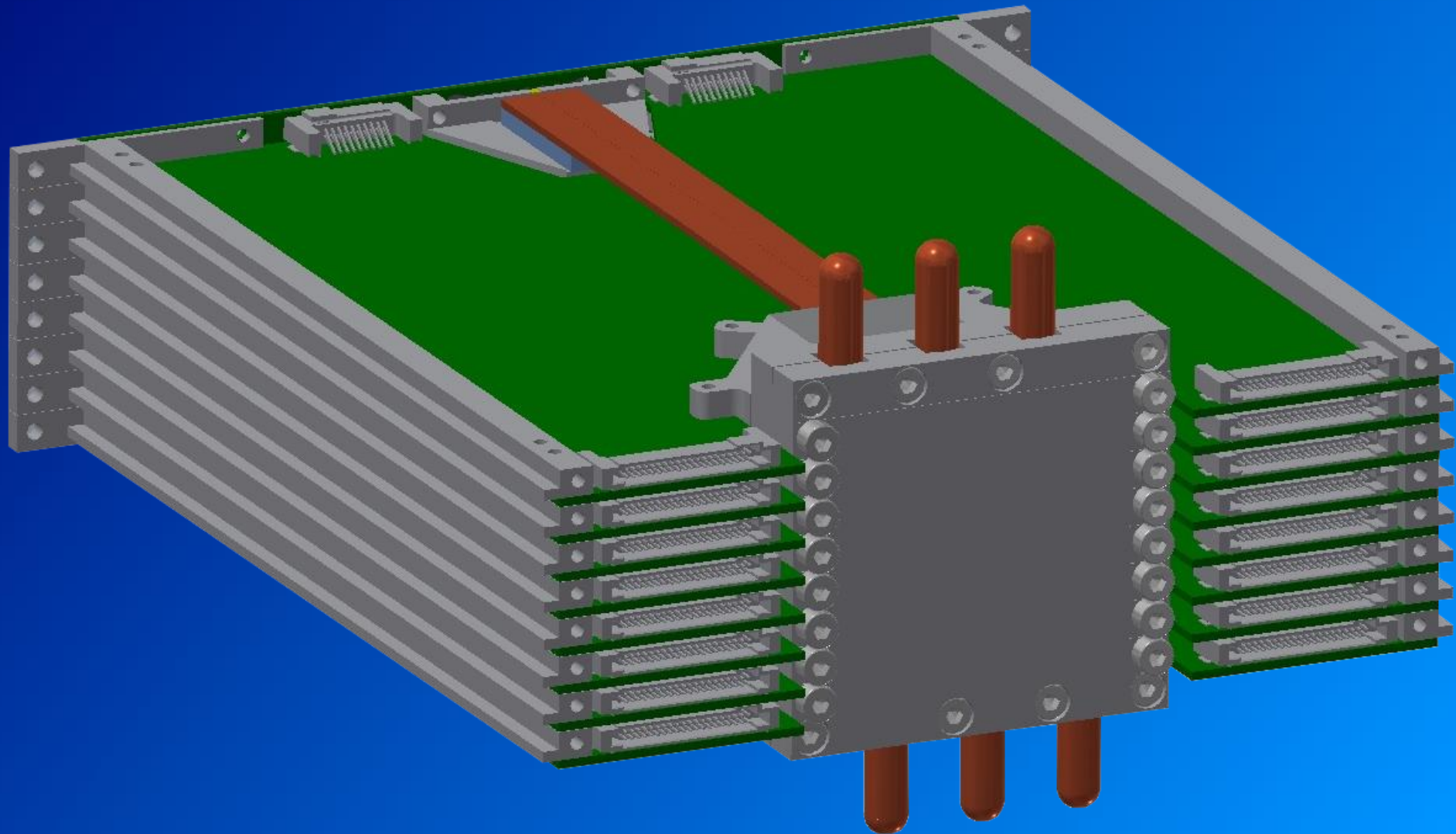




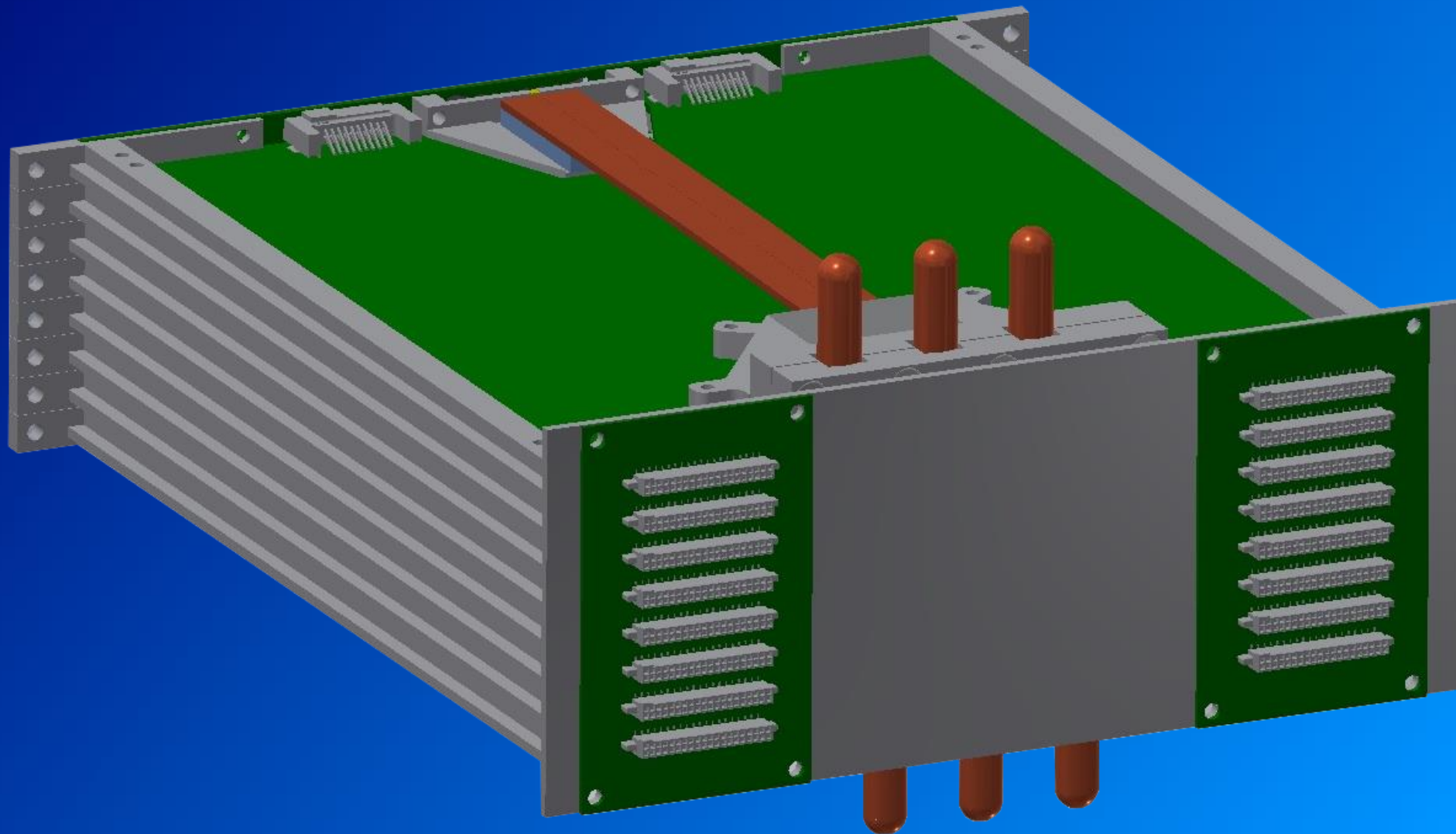
# Detection head stack



# Detection head stack



# Detection head stack



# Backend electronics

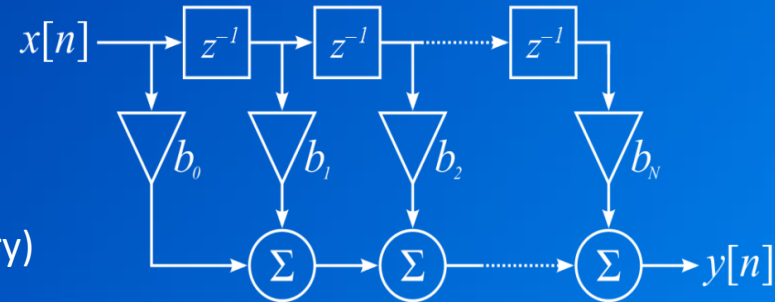
- Its purposes are
  - the configuration of the instrument
  - the digitization and elaboration of the analog signals
  - the acquisition of histograms or raw data for system analysis
  - the communication with the controlling computer
- It features an 8 channel, 40 MSPS, 12 bit ADC. Depending on the conditioning circuit bandwidth it can allow for shaper rise times as fast as 250 ns
- Noise filtering is accomplished by means of a low-power, high-performance ALTERA Cyclone 5 FPGA, which implements also the data buffers and the configuration and control logic
- It features an Ethernet port (possibly in a separated board) for network communication with a host computer

# Digital filtering

- Several options available, we selected the Finite Impulse Response (FIR) class because of its flexibility

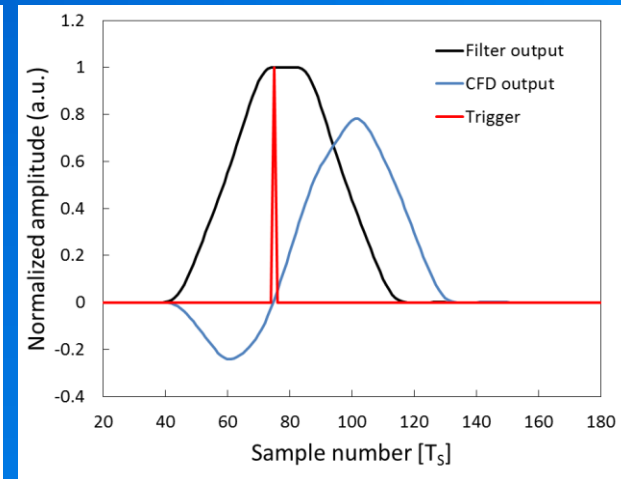
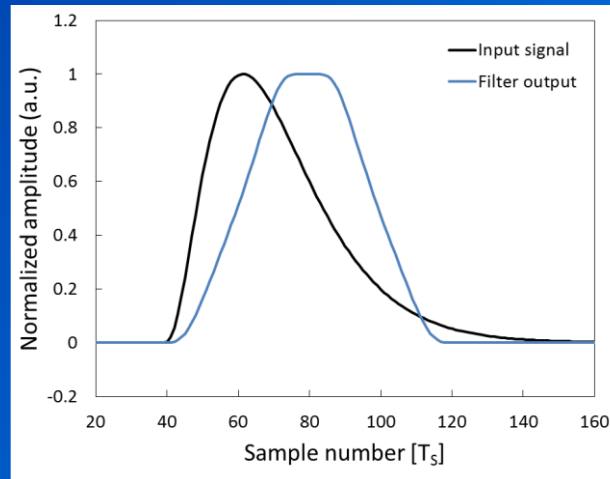
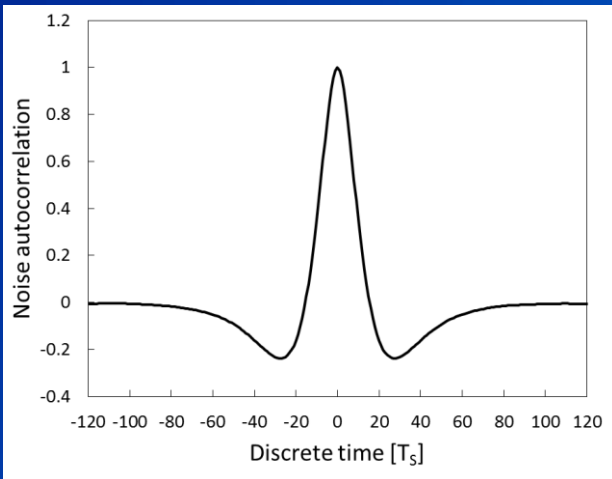
- Possible to constrain the filter synthesis

- accounting for the input signal noise
- optimizing the output shape (duration, flat top, symmetry)
- requiring rejection of low frequency pedestal variations
- minimize the ADC quantization noise

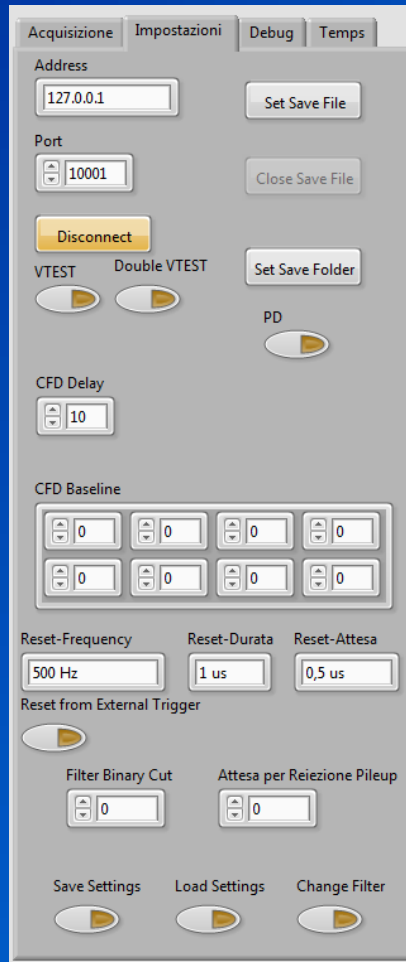


$$y(n) = b_0 \cdot x(n) + b_1 \cdot x(n-1) + \dots + b_N \cdot x(n-N)$$

- Digital filtering allows for exotic trigger functions, e.g. constant fraction discrimination



# LabVIEW DAQ – detector setup



# LabVIEW DAQ – normal mode

Acquisizione Impostazioni Debug Temps

Multigraph from FPGA 1 Graph Common Histogram

Channels Enabled

Normal Mode Oscilloscope Mode

Thresholds Normal Mode

Common Threshold Normal Mode

Dead Times (us)

Pile-ups

Counts

Total Counts

Save Data

Autoscale X Autoscale Y

Tab Grafici

Acquiring Acquisition Time Analyzing

Instance Name

Acquire

Exit

Minutes to Wait Remaining time

Timed Acquire

Single Acquire

Segnala solo Acquisizione

Temperatura

Keep Measuring

Temperatura Valida

Errore Acq

main esempio 03 - trapezio 1.vi

41,4 °C

00000000

# LabVIEW DAQ – histogram mode

The screenshot displays the LabVIEW DAQ histogram mode interface, organized into several functional areas:

- Acquisition Settings (Left Panel):**
  - Channels Enabled:** A grid of 8 yellow buttons representing active channels.
  - Normal Mode / Oscilloscope Mode:** A tabbed interface currently set to Normal Mode.
  - Thresholds Normal Mode:** Eight numeric input fields, each set to the value 4.
  - Common Threshold Normal Mode:** A numeric input field set to 4 and a 'Set' button.
  - Dead Times (us):** Two rows of four numeric input fields, each set to 1389,87.
  - Pile-ups:** Two rows of four numeric input fields with values: 6436538, 5599430, 7128001, 2560570 (top row); 2645361, 9886017, 5078443, 7435912 (bottom row).
  - Counts:** Two rows of four numeric input fields with values: 996, 1023, 1014, 1017 (top row); 987, 1022, 991, 1000 (bottom row).
  - Total Counts:** A numeric input field showing 8050 and a 'Save Data' button.
- Histograms' Offsets (Middle Panel):** Eight numeric input fields, each set to 0, corresponding to channels CH1 through CH8 and Mem. A 'Save Histograms' button is located below.
- Histograms (Right Panel):** A plot area titled 'Histograms' showing a multi-colored histogram with two distinct peaks. The x-axis ranges from 1226 to 1881, and the y-axis ranges from 0 to 90. A 'Linear Y Scale' button and a 'Flush Histograms' button are located above the plot.
- Control Panel (Bottom):**
  - Tab Grafici:** Includes 'Acquiring' (green indicator), 'Acquisition Time' (100 ms), and 'Analyzing' (green indicator).
  - Buttons:** 'Acquire', 'Timed Acquire', and 'Single Acquire'.
  - Parameters:** 'Minutes to Wait' (5), 'Remaining time' (00:00), and 'Exit' (red stop button).
  - Instance Name:** A text field containing 'main esempio 03 - trapezio 1.vi'.
  - Temperature Monitoring:** 'Temperatura' (41,4 °C), 'Temperatura Validata' (green indicator), and 'Errore Acq' (00000000).
  - Other:** 'Keep Measuring' button and 'Segnala solo Acquisizione' button.



# LabVIEW DAQ – oscilloscope mode

Acquisizione Impostazioni Debug Temps

Multigraph from FPGA 1 Graph Common Histogram

Channels Enabled

Normal Mode Oscilloscope Mode

Thresholds: Oscilloscope Mode

Common Threshold Oscilloscope Mode

Auto Trigger Horizontal Position Save Data

Filtered Signal

Autoscale X Autoscale Y

Tab Grafici

Acquiring Acquisition Time Analyzing

Instance Name

main esempio 03 - trapezio 1.vi

Acquire Timed Acquire Single Acquire

Minutes to Wait Remaining time

Exit

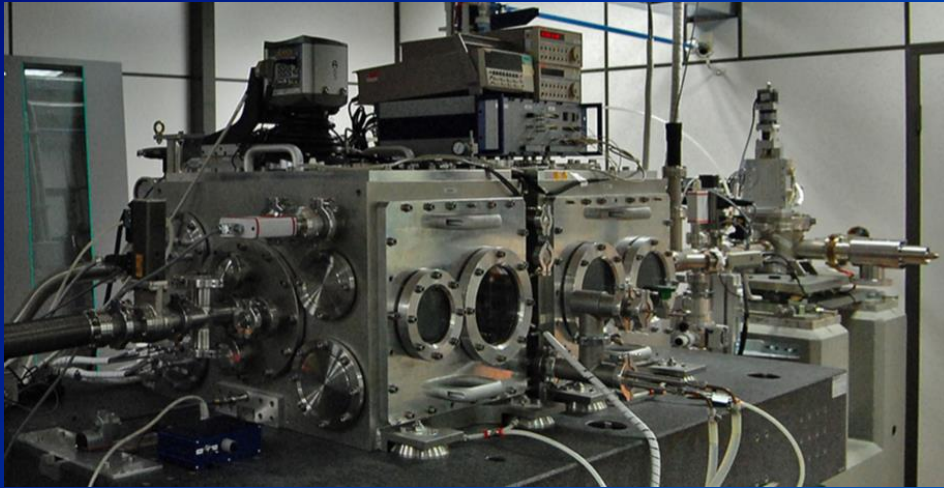
Temperatura

Keep Measuring 16,7 °C

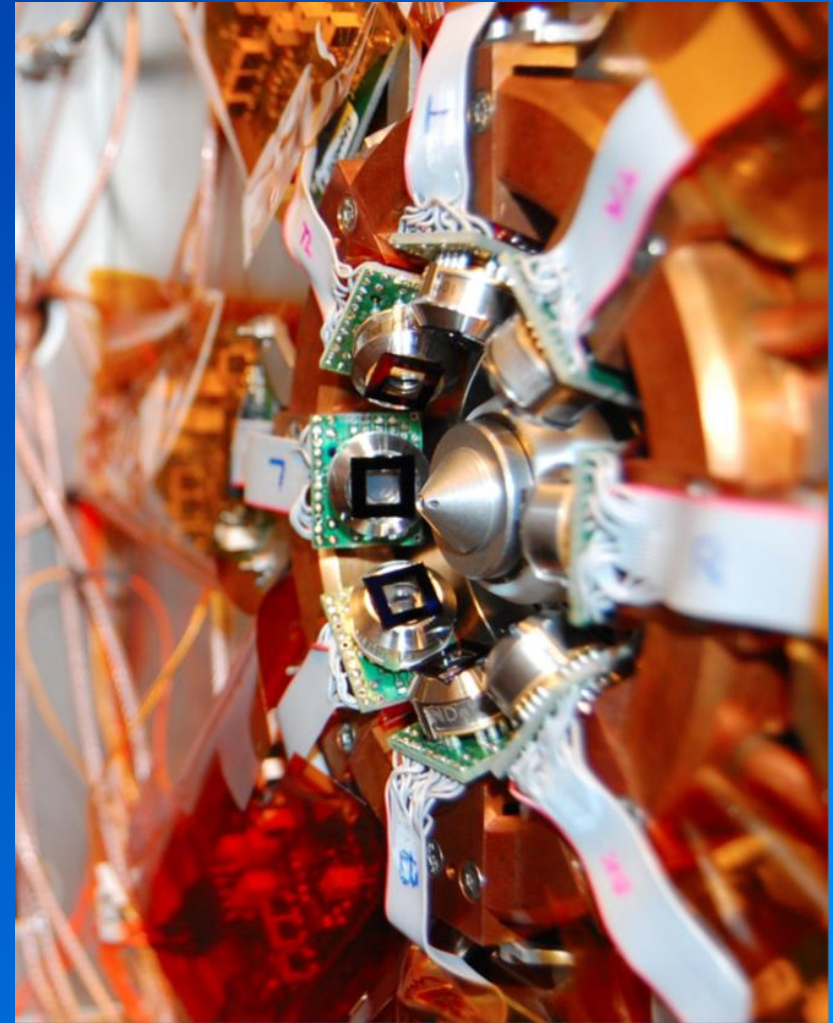
Temperatura Valida Errore Acq

00000000

# Development for Elettra/TwinMic

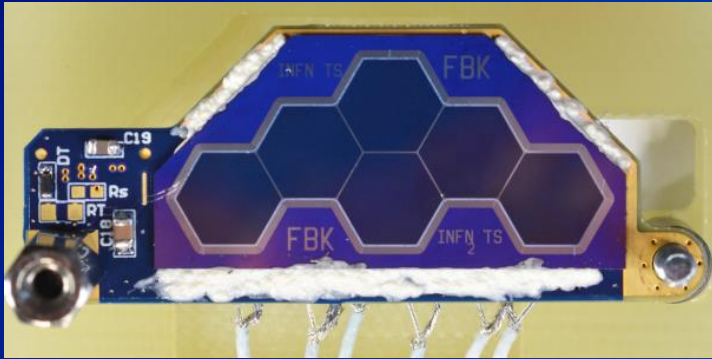


- Combination of scanning and full-field imaging in a single instrument
- Energy range 400 – 2200 eV, lateral resolution of 30 nm – 1 mm
- Goal of the project: an order of magnitude reduction of the measurement time
  - Improved measurement throughput
  - Reduced damage to the sample
  - Alternatively, acquire larger maps

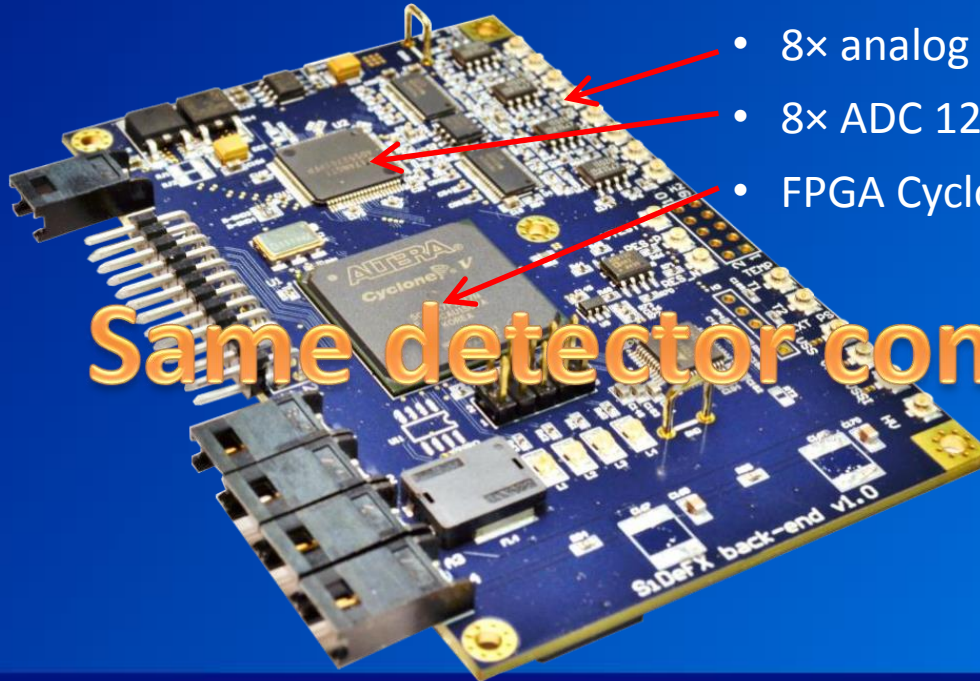


8× PNSensor SDDs (collimated 20 – 30 mm<sup>2</sup>) arranged on a copper ring used for cooling

# The new TwinMic detector system



- 6 not collimated hexagonal pixels (total area of 182 cm<sup>2</sup>) read out by SIRIO preamplifiers



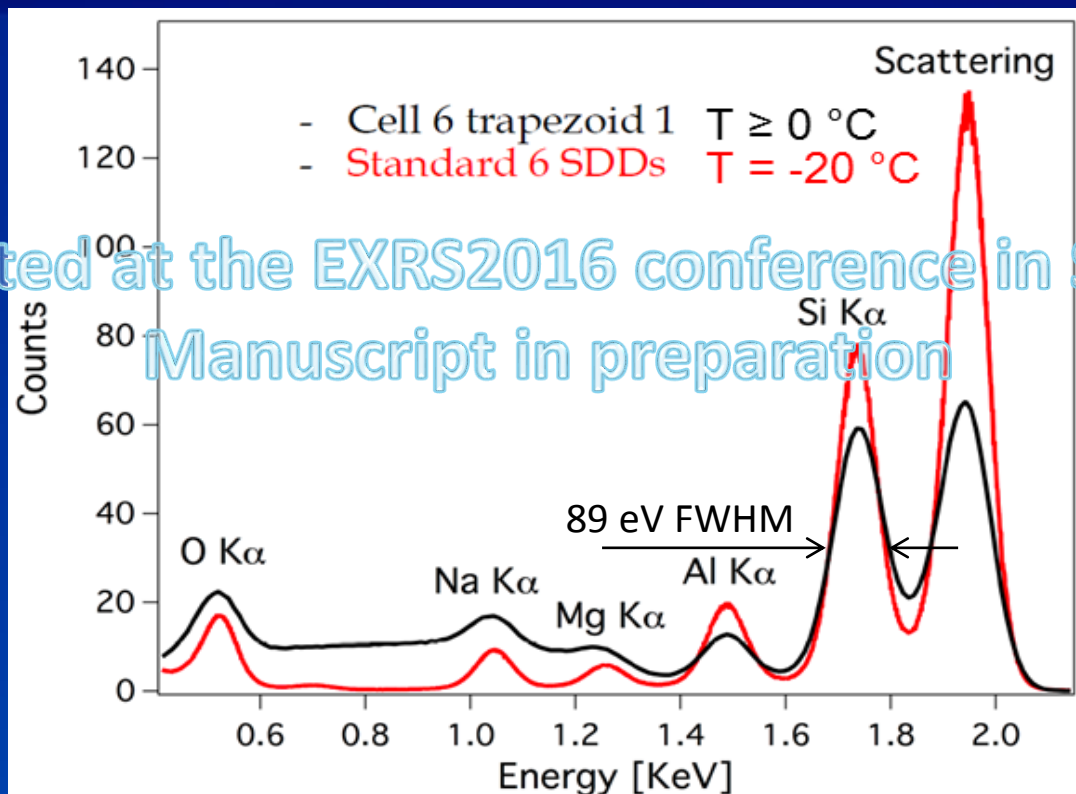
- 8× analog CR-RC<sup>2</sup> filters
- 8× ADC 12 bit 40 MSPS
- FPGA Cyclone 5

Same detector concept of SESAME



Four detectors mounted in the experimental chamber in vacuum conditions; for the test the distance from the sample was not yet optimal

# Beamline measurements



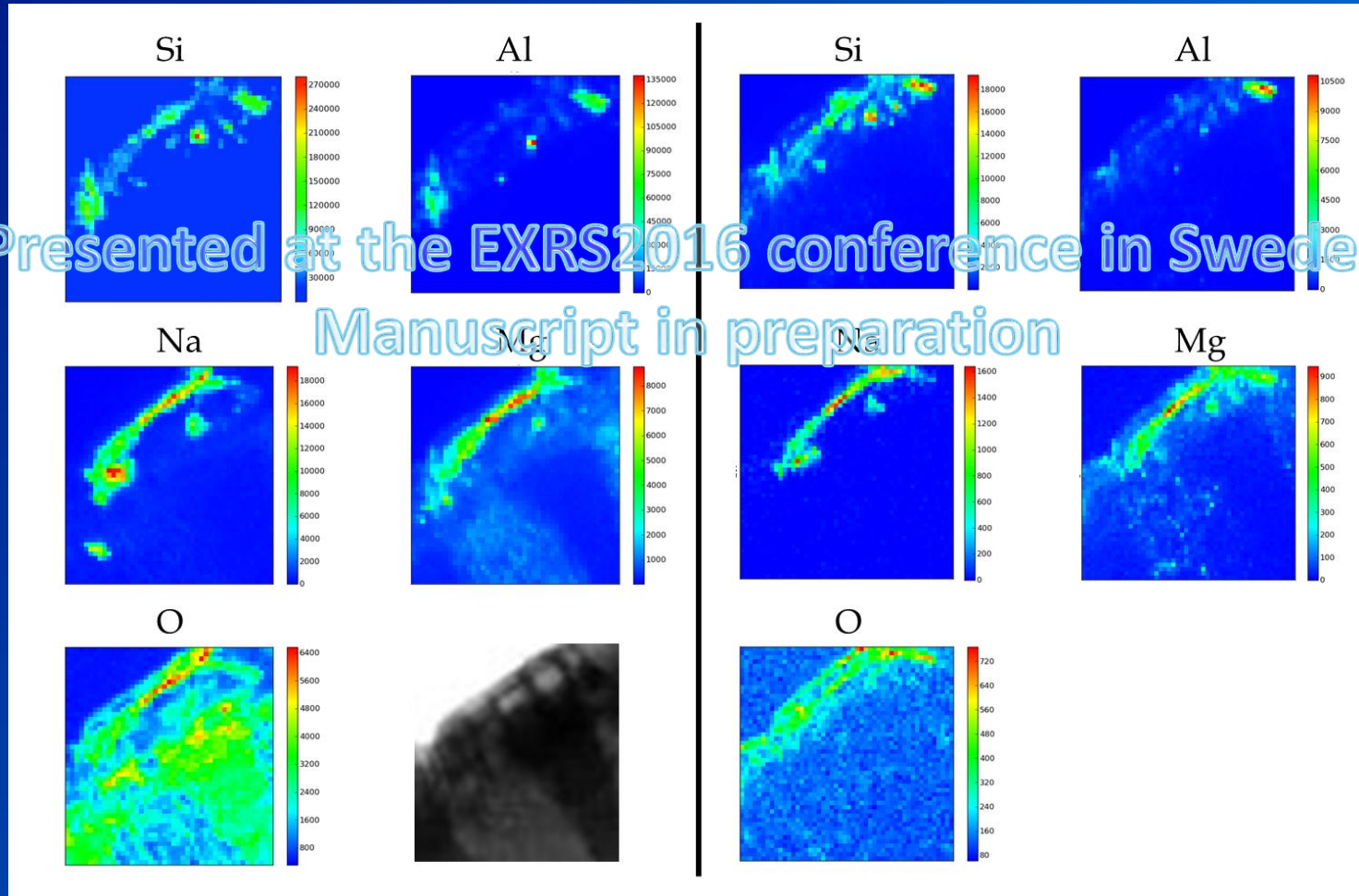
Si-Al-Mg-Na-O spectra of a *euphorbia ptyusa* plant section acquired with one cell of the new TwinMic detector and with 6 SDDs of the standard system

- Optimized digital filtering not yet available at that time,  $t_R = 0.95 \mu\text{s}$
- Relevant background below 1.4 keV (electrons extracted from the sample?)
- Successive test with new mechanical support showed a doubling of the rate

# Beamline measurements

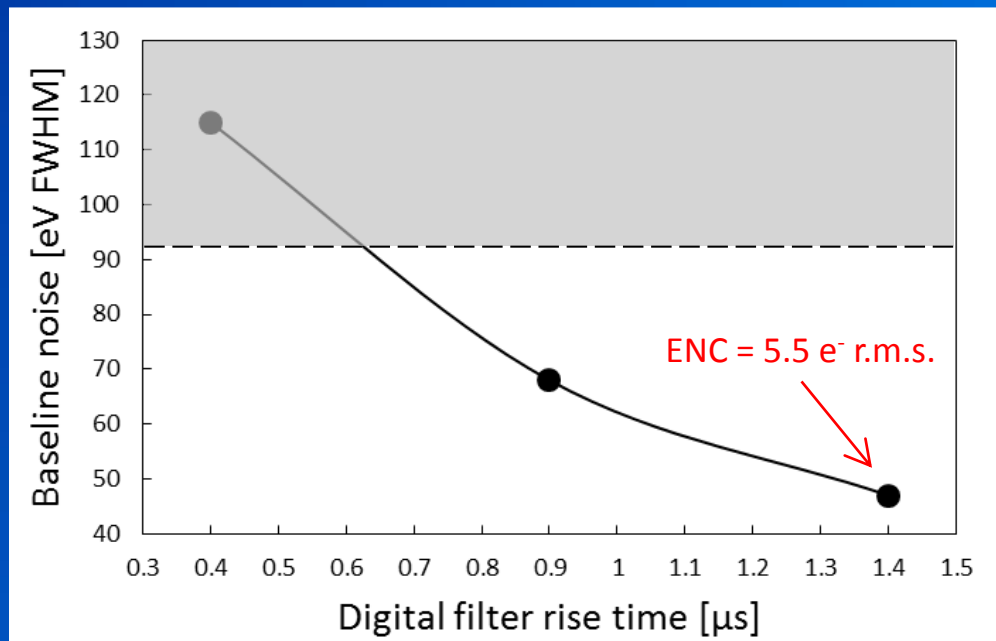
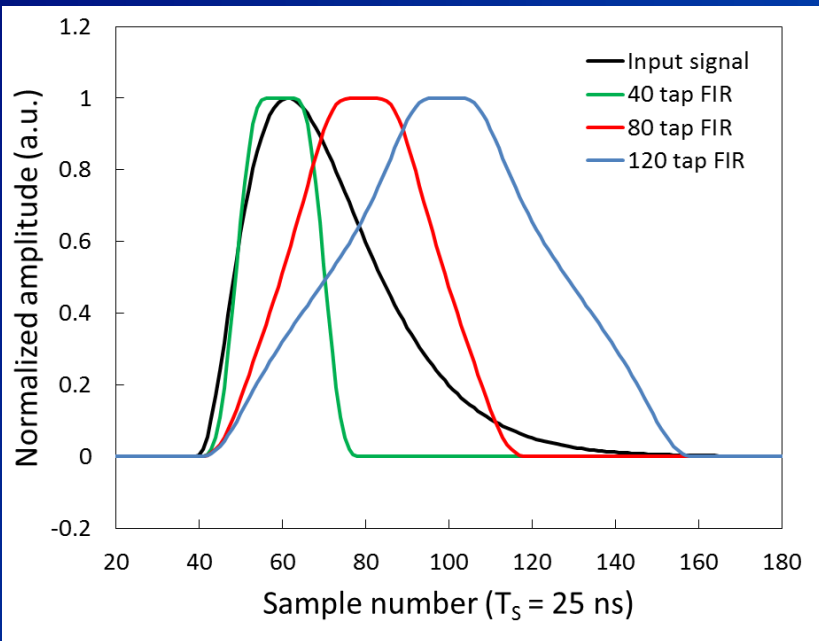
6 cells of the standard detector

Cell #1 of trapezoid #1



Elemental maps of the *euphorbia pityusa* plant section together with the corresponding absorption image

# Laboratory measurements at 0 °C



- Energy calibration with a  $^{55}\text{Fe}$  radioactive source
- Digital filter coefficients optimized considering the noise autocorrelation function
- Distortion present on the analog signal  $\rightarrow$  noise evaluated from the baseline fluctuations
- Fast filter worsens the resolution of the analog pre-shaper because of the unmatched frequency bands, the other two filter performances are within SESAME specifications

# Conclusions

- The SESAME XAFS fluorescence detector under development is a state-of-the-art instrument:
  - it will sustain a rate of at least 50 kcps/cell ( $\approx 560$  kcps/cm<sup>2</sup>)
  - It will have a total sensitive area of 576 mm<sup>2</sup> allowing for a total rate of at least 3.2 Mcps
  - It will have an energy resolution  $< 150$  eV FWHM @ 5.9 keV, 0 °C with a peaking time  $\leq 1$   $\mu$ s
- The detector concept is being tested and optimized by way of two parallel developments for Elettra Sincrotrone Trieste (XAFS and TwinMic beamlines) with good results
- The timeframe set for this project forced us to consider conservative solutions, nonetheless further optimizations and improvements of such detector are possible and will be pursued in future developments